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Vishay Siliconix

P-Channel 40-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)	Q _g (TYP.)			
-40	0.0081 at V _{GS} = -10 V	-50 ^d	60			
-40	0.0117 at V _{GS} = -4.5 V	-48 ^d	00			



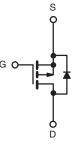
FEATURES

- TrenchFET® power MOSFET
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



APPLICATIONS

- Power switch
- Load switch in high current applications
- DC/DC converters



P-Channel MOSFET

Ordering Information:

SUD50P04-08-GE3 (lead (Pb)-free and halogen-free)

PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V _{DS}	-40			
Gate-Source Voltage	V _{GS}	± 20			
Ossilia a a Daria Ossal (T. 150.00)	T _C = 25 °C		-50 ^d		
Continuous Drain Current (T _J = 150 °C)	T _C = 70 °C	I _D	-50 ^d	٦ ,	
Pulsed Drain Current	I _{DM}	-100	A		
Avalanche Current	I _{AS}	-46			
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	106	mJ	
Maximum Dawar Dissipation 3	T _C = 25 °C	В	73.5 ^b	W	
Maximum Power Dissipation ^a	T _A = 25 °C °	P _D	2.5		
Operating Junction and Storage Temperature Ra	nge	T _J , T _{stg}	-55 to +150	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	LIMIT	UNIT		
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	50	°C/W		
Junction-to-Case (Drain)	R _{thJC}	1.7	C/VV		

Notes

- a. Duty cycle ≤ 1 %.
- b. See SOA curve for voltage derating.
- c. When mounted on 1" square PCB (FR-4 material).
- d. Package limited.

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = -250 μA	; = 0 V, I _D = -250 μA -40 -		-	.,	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-1	-	-2.5	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 250	nA	
		V _{DS} = -40 V, V _{GS} = 0 V	-	-	-1	μΑ	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$	-	-	-50		
		$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 150 ^{\circ}\text{C}$	-	-	-250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -10 \text{ V}, V_{GS} = -10 \text{ V}$	-50	-	-	Α	
Drain-Source On-State Resistance a	R _{DS(on)}	$V_{GS} = -10 \text{ V}, I_D = -22 \text{ A}$	-	0.0067	0.0081	Ω	
Brain Godroe on Glate Nesistance	11DS(on)	$V_{GS} = -4.5 \text{ V}, I_D = -19 \text{ A}$	-	0.0097	0.0117	122	
Forward Transconductance a	9fs	$V_{DS} = -15 \text{ V}, I_{D} = -22 \text{ A}$	-	45	-	S	
Dynamic ^b							
Input Capacitance	C _{iss}		-	5380	-	pF	
Output Capacitance	Coss	V _{GS} = 0 V, V _{DS} = -20 V, f = 1 MHz	-	570	-		
Reverse Transfer Capacitance	C _{rss}		-	500	-		
Total Gate Charge c		$V_{DS} = -20 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -20 \text{ A}$	-	106	159	nC	
Total Gate Charge	Qg		-	60	90		
Gate-Source Charge ^c	Q_{gs}	$V_{DS} = -20 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -20 \text{ A}$	-	22	-		
Gate-Drain Charge ^c	Q_{gd}		-	27	-		
Gate Resistance	R_g	f = 1 MHz	0.4	1.8	3.6	Ω	
Turn-On Delay Time ^c	t _{d(on)}		-	15	23		
Rise Time ^c	t _r	V_{DD} = -20 V, R_L = 2 Ω	-	12	18	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong -10 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$	-	70	105		
Fall Time ^c	t _f		-	18	27		
Drain-Source Body Diode Ratings at	nd Characteri	stics (T _C = 25 °C) b					
Continuous Current	I _S		-	-	-50	۸	
Pulsed Current	I _{SM}		-	-	-100	Α	
Forward Voltage ^a	V _{SD}	I _F = -10 A, V _{GS} = 0 V	-	-0.8	-1.5	٧	
Reverse Recovery Time	trr		-	35	53	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	l _F = -10 A, dl/dt = 100 A/μs	-	-2	-3	Α	
Reverse Recovery Charge	Q _{rr}		-	33	50	nC	

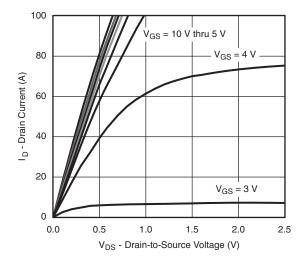
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

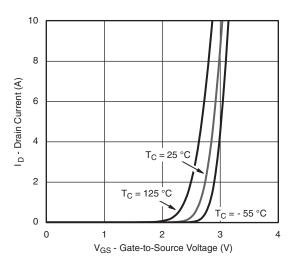
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



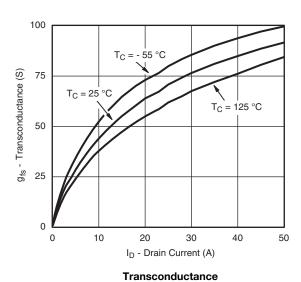
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

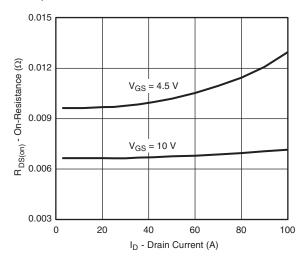


Output Characteristics

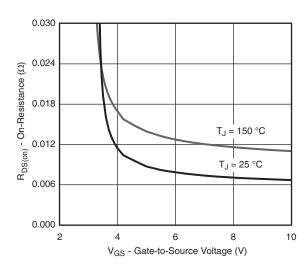


Transfer Characteristics

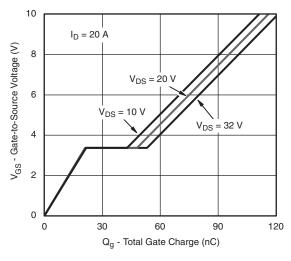




On-Resistance vs. Drain Current

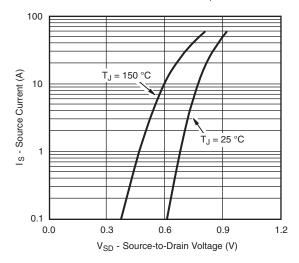


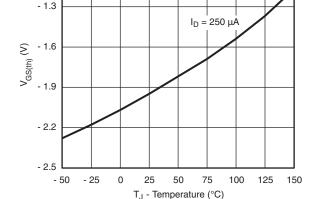
On-Resistance vs. Gate-to-Source Voltage





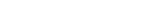
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



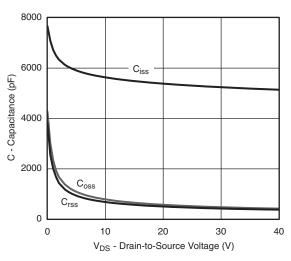


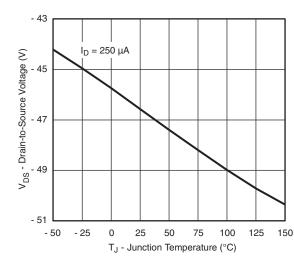
Threshold Voltage

Source-Drain Diode Forward Voltage



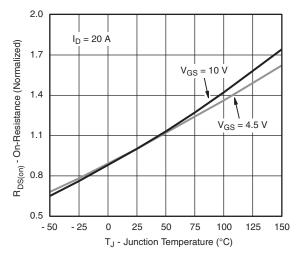
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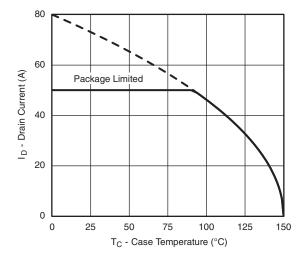




Capacitance

Drain Source Breakdown vs. Junction Temperature

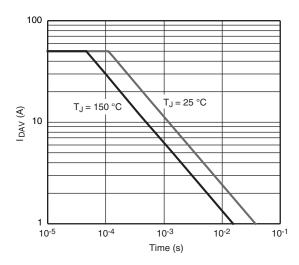




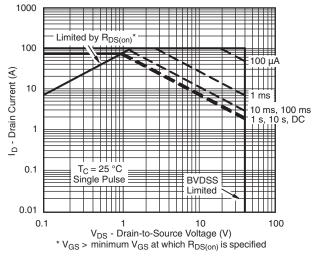
On-Resistance vs. Junction Temperature



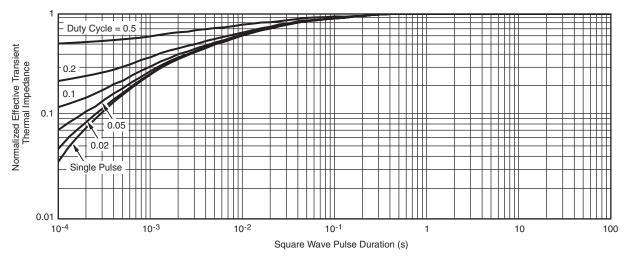
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Single Pulse Avalanche Current Capability vs. Time

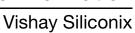


Safe Operating Area



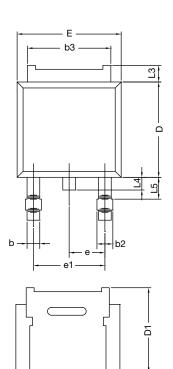
Normalized Thermal Transient Impedance, Junction-to-Case

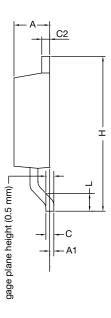
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?65594.





TO-252AA Case Outline





	MILLIMETERS		INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	4.10	-	0.161	-	
Е	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
e	2.28	BSC 0.090 BSC		BSC	
e1	4.56 BSC		0.180 BSC		
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.01	1.52	0.040	0.060	
ECN: T16-0236-Rev. P, 16-May-16					

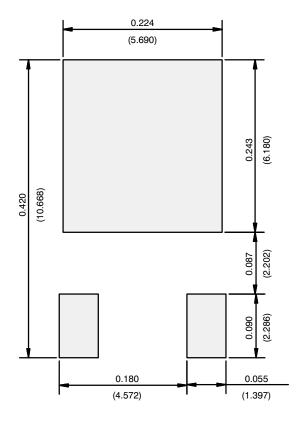
DWG: 5347

Notes

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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